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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details	
Product Status	Obsolete
Core Processor	Coldfire V4
Core Size	32-Bit Single-Core
Speed	162MHz
Connectivity	EBI/EMI, I ² C, UART/USART
Peripherals	DMA, WDT
Number of I/O	16
Program Memory Size	-
Program Memory Type	ROMIess
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	1.65V ~ 3.6V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	208-BFQFP
Supplier Device Package	208-FQFP (28x28)
Purchase URL	https://www.e-xfl.com/pro/item?MUrl=&PartUrl=mcf5407cft162

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1.3.2.1 16-Kbyte Instruction Cache/8-Kbyte Data Cache

The MCF5407 Harvard architecture includes a 16-Kbyte instruction cache and an 8-Kbyte data cache. These four-way, set-associative caches provide pipelined, single-cycle access on cached instructions and operands.

As with all ColdFire caches, the cache controllers implement a non-lockup, streaming design. The use of processor-local memories decouples performance from external memory speeds and increases available bandwidth for external devices or the on-chip 4-channel DMA.

Both caches implement line-fill buffers to optimize 16-byte line burst accesses. Additionally, the data cache supports copyback, write-through, or cache-inhibited modes. A 4-entry, 32-bit buffer is used for cache line push operations and can be configured for deferred write buffering in write-through or cache-inhibited modes.

The INTOUCH instruction can be used to prefetch instructions that, when used with the cache locking feature, cannot be displaced from the instruction cache by instruction cache misses. This function may be desirable in systems where deterministic real-time performance is critical.

1.3.2.2 Internal 2-Kbyte SRAMs

Two 2-Kbyte on-chip SRAM modules are also connected to the Harvard memory architecture and provide pipelined, single-cycle access to memory regions mapped to these devices. Each memory can be independently mapped to any 0-modulo-2K location in the 4-Gbyte address space and can be configured either for instruction or data accesses. Time-critical functions can be mapped onto the instruction memory bus, while the system stack or heavily-referenced data operands can be mapped onto the data bus.

1.3.3 DRAM Controller

The MCF5407 DRAM controller provides a direct interface for up to two blocks of DRAM. The controller supports 8-, 16-, or 32-bit memory widths and can easily interface to PC-100 DIMMs. A unique addressing scheme allows for increases in system memory size without rerouting address lines and rewiring boards. The controller operates in normal mode or in page mode and supports SDRAMs and EDO DRAMs.

1.3.4 DMA Controller

The MCF5407 provides four fully programmable DMA channels for quick data transfer. Dual- and single-address modes support bursting and cycle steal. Data transfers are 32 bits long with packing and unpacking supported along with an auto-alignment option for efficient block transfers. Automatic block transfers from on-chip serial UARTs are also supported through the DMA channels.







2.2.2.2 Vector Base Register (VBR)

The VBR holds the base address of the exception vector table in memory. The displacement of an exception vector is added to the value in this register to access the vector table. VBR[19–0] are not implemented and are assumed to be zero, forcing the vector table to be aligned on a 0-modulo-1-Mbyte boundary.

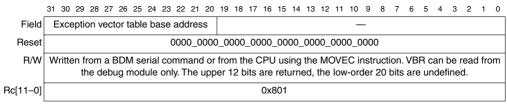


Figure 2-6. Vector Base Register (VBR)

2.2.2.3 Cache Control Register (CACR)

The CACR controls operation of both the instruction and data cache memory. It includes bits for enabling, freezing, and invalidating cache contents. It also includes bits for defining the default cache mode and write-protect fields. See Section 4.10.1, "Cache Control Register (CACR)."

2.2.2.4 Access Control Registers (ACR0-ACR3)

The access control registers (ACR0–ACR3) define attributes for four user-defined memory regions. ACR0 and ACR1 control data memory space and ACR2 and ACR3 control instruction memory space. Attributes include definition of cache mode, write protect and buffer write enables. See Section 4.10.2, "Access Control Registers (ACR0–ACR3)."

2.2.2.5 RAM Base Address Registers (RAMBAR0 and RAMBAR1)

The RAMBAR registers determine the base address location of the internal SRAM modules and indicate the types of references mapped to each. Each RAMBAR includes a base address, write-protect bit, address space mask bits, and an enable. The RAM base address must be aligned on a 0-module-2-Kbyte boundary. See Section 4.4.1, "SRAM Base Address Registers (RAMBAR0/RAMBAR1)."

2.2.2.6 Module Base Address Register (MBAR)

The module base address register (MBAR) defines the logical base address for the memory-mapped space containing the control registers for the on-chip peripherals. See Section 6.2.2, "Module Base Address Register (MBAR)."





BSR

BSR	Branch to Subroutine
Operation:	SP - 4 \rightarrow SP; PC \rightarrow (SP); PC + d _n \rightarrow PC
Assembler Syntax:	BSR <label></label>
Attributes:	Size = byte, word, long
Description: Pushes	s the word address of the instruction immediately for

Description: Pushes the word address of the instruction immediately following the BSR instruction onto the system stack. The PC contains the address of the instruction word, plus two. Program execution then continues at location (PC) + displacement. The displacement is a two's complement integer that represents the relative distance in bytes from the current PC to the destination PC. If the 8-bit displacement field in the instruction word is 0, a 16-bit displacement (the word immediately following the instruction) is used. If the 8-bit displacement field in the instruction is used. If the 8-bit displacement (longword immediately following the instruction) is used.

Condition Codes: Not affected

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Instruction	0	0 1 1 0 0 0 1 8-bit displacement														
Format: 16-bit displacement if 8-bit displacement = 0x00																
32-bit displacement if 8-bit displacement = 0xFF																

Instruction Fields:

- 8-bit displacement field Two's complement integer specifying the number of bytes between the branch instruction and the next instruction to be executed.
- 16-bit displacement field—Used for displacement when the 8-bit displacement contains 0x00.
- 32-bit displacement field—Used for displacement when the 8-bit displacement contains 0xFF.

NOTE:

A branch to the next immediate instruction automatically uses the 16-bit displacement format because the 8-bit displacement field contains 0x00 (zero offset).

BSR	V2, V3 Core	V4 Core		
Opcode present	Yes	Yes		
Operand sizes supported	.b, .w	.b, .w, .l		



Bits	Name	Description
6	_	Reserved, should be cleared.
5–1	C/I, SC, SD, UC, UD	Address space masks (ASn). These fields allow certain types of accesses to be masked, or inhibited from accessing the SRAM module. These bits are useful for power management as described in Section 4.6, "Power Management." In particular, C/I is typically set. The address space mask bits are follows: C/I = CPU space/interrupt acknowledge cycle mask. Note that C/I must be set if BA = 0. SC = Supervisor code address space mask D = Supervisor data address space mask UC = User code address space mask UD = User code address space mask For each ASn bit: 0 An access to the SRAM module can occur for this address space 1 Disable this address space from the SRAM module. If a reference using this address space is made, it is inhibited from accessing the SRAM module and is processed like any other non-SRAM reference.
0	V	Valid. Enables/disables the SRAM module. V is cleared at reset. 0 RAMBAR contents are not valid. 1 RAMBAR contents are valid.

Table 4-1. RAMBARn Field Description (Continued)

The mapping of a given access into the RAM uses the following algorithm to determine if the access hits in the memory:

ASn refers to the five address space mask bits: C/I, SC, SD, UC, and UD.

4.5 SRAM Initialization

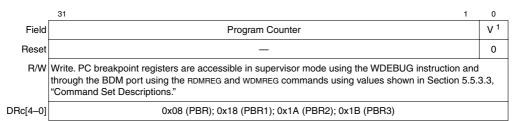
After a hardware reset, the contents of each SRAM module are undefined. The valid bits, RAMBAR*n*[V], are cleared, disabling the SRAM modules. If the SRAM requires initialization with instructions or data, the following steps should be performed:

1. Load RAMBARn with bit 7 = 0, mapping the SRAM module to the desired location. Clearing RAMBARn[7] logically connects the SRAM module to the processor's data bus.





program counter register when the appropriate valid bit is set and TDR and/or XTDR are configured appropriately. PBR bits are masked by clearing corresponding PBMR bits. Results are compared with the processor's program counter register, as defined in TDR and/or XTDR. PBR1–PBR3 are not masked. Figure 5-11 shows the PC breakpoint register.



¹ PBR does not have a valid bit. PBR[0] is read as 0 and should be cleared.

Figure 5-11. Program Counter Breakpoint Registers (PBR, PBR1, PBR2, PBR3)

Table 5-15 describes PBR, PBR1, PBR2, and PBR3 fields.

Table 5-15. PBR, PBR1, PBR2, PBR3 Field Descriptions

Bits	Name	Description
31–1	Address	PC breakpoint address. The 31-bit address to be compared with the PC as a breakpoint trigger. PBR does not have a valid bit.
0	V	Valid. Breakpoint registers are compared with the processor's program counter register when the appropriate valid bit is set and TDR and/or XTDR are configured appropriately. This bit is not implemented on PBR.

PBMR is accessible in supervisor mode as debug control register 0x09 using the WDEBUG instruction and via the BDM port using the WDMREG command. Figure 5-12 shows PBMR.

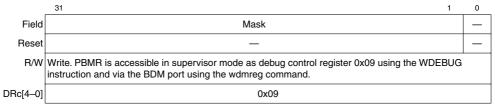


Figure 5-12. Program Counter Breakpoint Mask Register (PBMR)

Table 5-16 describes PBMR fields.

Table 5-16. PBMR Field Descriptions

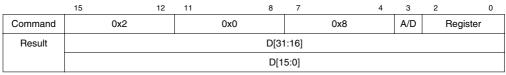
Bits	Name	Description
31–0	Mask	PC breakpoint mask. A zero in a bit position causes the corresponding PBR bit to be compared to the appropriate PC bit. Set PBMR bits cause PBR bits to be ignored.



5.5.3.3.2 Write A/D Register (WAREG/WDREG)

The operand longword data is written to the specified address or data register. A write alters all 32 register bits. A bus error response is returned if the CPU core is not halted.

Command Format:





Command Sequence



Figure 5-23. WAREG/WDREG Command Sequence

- Operand Data Longword data is written into the specified address or data register. The data is supplied most-significant word first.
- Result Data Command complete status is indicated by returning 0xFFFF (with S cleared) when the register write is complete.



5.5.3.3.10 Read Control Register (RCREG)

Read the selected control register and return the 32-bit result. Accesses to the processor/memory control registers are always 32 bits wide, regardless of register width. The second and third words of the command form a 32-bit address, which the debug module uses to generate a special bus cycle to access the specified control register. The 12-bit Rc field is the same as that used by the MOVEC instruction.

Command/Result Formats:

	15	12	11	8	7	4	3	0
Command	0x2		0x9			0x8	0	x0
	0x0		0x0			0x0	0	x0
	0x0					Rc		
Result			D[31:16]					
			D[15:0]					

Figure 5-38. RCREG Command/Result Formats

Rc encoding:

Table	5-23.	Control	Register	Мар
-------	-------	---------	----------	-----

Rc	Register Definition	Rc	Register Definition
0x002	Cache control register (CACR)	0x805	MAC mask register (MASK)
0x004	Access control register 0 (ACR0)	0x806	MAC accumulator (ACC)
0x005	Access control register 1 (ACR1)	0x80E	Status register (SR)
0x006	Access control register 2 (ACR2)	0x80F	Program register (PC)
0x007	Access control register 2 (ACR3)	0xC04	RAM base address register (RAMBAR0)
0x801	Vector base register (VBR)	0xC05	RAM base address register (RAMBAR1)
0x804	MAC status register (MACSR)	0xC0F	Memory base address (MBAR)

Command Sequence:

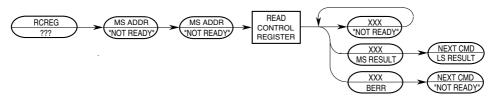


Figure 5-39. RCREG Command Sequence

Operand Data:	The only operand is the 32-bit Rc control register select field.
Result Data:	Control register contents are returned as a longword,
	most-significant word first. The implemented portion of registers
	smaller than 32 bits is guaranteed correct; other bits are undefined.





Chapter 6 SIM Overview

This chapter provides detailed operation information regarding the system integration module (SIM). It describes the SIM programming model, bus arbitration, and system-protection functions for the MCF5407.

6.1 Features

The SIM, shown in Figure 6-1, provides overall control of the bus and serves as the interface between the ColdFire core processor complex and the internal peripheral devices.

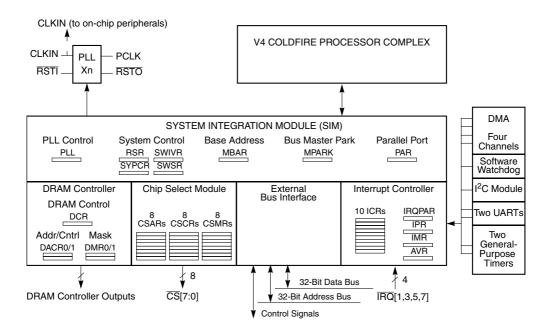


Figure 6-1. SIM Block Diagram



6.2 Programming Model

The following sections describe the registers incorporated into the SIM.

6.2.1 SIM Register Memory Map

Table 6-1 shows the memory map for the SIM registers. The internal registers in the SIM are memory-mapped registers offset from the MBAR address pointer defined in MBAR[BA]. This supervisor-level register is described in Section 6.2.2, "Module Base Address Register (MBAR)." Because SIM registers depend on the base address defined in MBAR[BA], MBAR must be programmed before SIM registers can be accessed.

NOTE:

Although external masters cannot access the MCF5407's on-chip memories or MBAR, they can access any of the SIM memory map and peripheral registers, such as those belonging to the interrupt controller, chip-select module, UARTs, timers, DMA, and I^2C .

MBAR Offset	[31:24]	[31:24] [23:16] [15:8]					
0x000	Reset status register (RSR) [p. 6-5]	System protection control register (SYPCR) [p. 6-8]	Software watchdog interrupt vector register (SWIVR) [p. 6-9]	Software watchdog service register (SWSR) [p. 6-9]			
0x004	Pin assignment reg	ister (PAR) [p. 6-10]	Interrupt port assignment register (IRQPAR) [p. 9-7]	Reserved			
0x008	PLL control (PLLCR) [p. 7-3]		Reserved				
0x00C	Default bus master park register (MPARK) [p. 6-11]	Reserved					
0x010– 0x03C							
		Interrupt Controller Reg	isters [p. 9-2]				
0x040	0x040 Interrupt pending register (IPR) [p. 9-6]						
0x044	0x044 Interrupt mask register (IMR) [p. 9-6]						
0x048	8 Reserved Autovector register (AVR) [p. 9-5]						
	l	nterrupt Control Registers	(ICRs) [p. 9-3]				

Table 6-1. SIM Registers



6.2.10 Bus Arbitration Control

This section describes the bus arbitration register and the four arbitration schemes.

6.2.10.1 Default Bus Master Park Register (MPARK)

The MPARK, shown in Figure 6-9, determines the default bus master arbitration between internal transfers (core and DMA module) and between internal and external transfers to internal resources. This arbitration is needed because external masters can access internal registers within the MCF5407 peripherals.

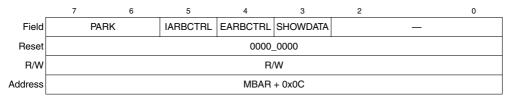


Figure 6-9. Default Bus Master Register (MPARK)

Table 6-6 describes MPARK bits.

Table 6	6.	MPARK	Field	Descri	otions
	,		i iciu	DCSCII	

Bits	Name	Description
7–6	PARK	Park. Indicates the arbitration priority of internal transfers among MCF5407 resources. 00 Round-robin between DMA and ColdFire core 01 Park on master ColdFire core 10 Park on master DMA module 11 Park on current master Use of this field is described in detail in Section 6.2.10.1.1, "Arbitration for Internally Generated Transfers (MPARK[PARK])."
5	IARBCTRL	 Internal bus arbitration control. Controls external device access to the MCF5407 internal bus. O Arbitration disabled (single-master system) 1 Arbitration enabled. IARBCTRL must be set if external masters are using internal resources like the DRAM controller or chip selects. Use of this bit depends on whether the system has single or multiple masters, as follows: In a single-master system, IARBCTRL should stay cleared, disabling internal arbitration by external masters. In this scenario, MPARK[PARK] applies only to priority of internal masters over one another. Note that the internal DMA (master 3) has priority over the ColdFire core (master 2), if internal DMA bandwidth is at its maximum (BWC = 000). In multiple master systems that expect to use internal resources like the DRAM controller or chip selects, internal arbitration should be enabled. The external master defaults to the highest priority internal master anytime BG is negated.
4	EARBCTRL	External bus arbitration control. Enables internal register memory space to external bus arbitration. Internal registers are those accessed at offsets to the MBAR. These include the SIM, DMA, chip selects, timers, UARTs, I ² C, and parallel port registers. These registers do not include the MBAR; only the core can access the MBAR. 0 Arbitration disabled 1 Arbitration enabled The use of this field is described in detail in Section 6.2.10.1.2, "Arbitration between Internal and External Masters for Accessing Internal Resources."



Table 11-13 describes DACR*n* fields.

Table 11-13. DACR0/DACR1 Field Descriptions (Synchronous Mode)

Bit	Name	Description							
31–18	BA	Base address register. With DCMR[BAM], determines the address range in which the associated DRAM block is located. Each BA bit is compared with the corresponding address of the current bus cycle. If all unmasked bits match, the address hits in the associated DRAM block. BA functions the same as in asynchronous operation.							
17–16	-	Reserved, should be cleared.							
15	RE	Refresh enable. Determines when the DRAM cor block. 0 Do not refresh associated DRAM block 1 Refresh associated DRAM block	troller genera	ates a refresh	n cycle to the	DRAM			
14	-	Reserved, should be cleared.							
13–12	CASL	CAS latency. Affects the following SDRAM timing manufacturers. Refer to the SDRAM specification	•	0					
		B anana tan		Number of	Bus Clocks				
		Parameter	CASL= 00	CASL = 01	CASL= 10	CASL= 11			
		t _{RCD} —SRAS assertion to SCAS assertion	1	2	3	3			
		t _{CASL} —SCAS assertion to data out	1	2	3	3			
		t_{RAS} —ACTV command to precharge command	2	4	6	6			
		t_{RP} —Precharge command to ACTV command	1	2	3	3			
		t _{RWL} ,t _{RDL} —Last data input to precharge command	1	1	1	1			
		t_{EP} —Last data out to precharge command)	1	1	1	1			
11	_	Reserved, should be cleared.							
10–8	СВМ	Command and bank MUX [2:0]. Because different bank select lines to correspond to different addred determines the addresses onto which these funct CBM Command Bit Bank Select Bits 000 17 18 and up 001 18 19 and up 001 19 20 and up 011 20 21 and up 100 21 22 and up 101 22 23 and up 	sses, these r iions are mul me handle co	esources are tiplexed.	programmat	ole. CBM			
7									
7		select bits include a base bit and all address bits Reserved, should be cleared.	above for SD	RAMs with m	nultiple bank	select bit			



• Single-address transfers—An external device can initiate a single-address transfer by asserting DREQ. The MCF5407 provides address and control signals for single-address transfers. The external device reads to or writes from the specified address, as Figure 12-4 shows. External logic is required.

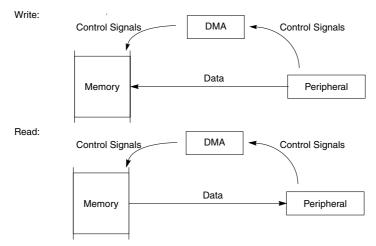


Figure 12-4. Single-Address Transfers

Any operation involving the DMA module follows the same three steps:

- 1. Channel initialization—Channel registers are loaded with control information, address pointers, and a byte-transfer count.
- 2. Data transfer—The DMA accepts requests for operand transfers and provides addressing and bus control for the transfers.
- 3. Channel termination—Occurs after the operation is finished, either successfully or due to an error. The channel indicates the operation status in the channel's DSR, described in Section 12.4.5, "DMA Status Registers (DSR0–DSR3)."

12.4 DMA Controller Module Programming Model

This section describes each internal register and its bit assignment. Note that there is no way to prevent a write to a control register during a DMA transfer. Table 12-3 shows the mapping of DMA controller registers.



12.4.1 Source Address Registers (SAR0–SAR3)

SAR*n*, Figure 12-5, contains the address from which the DMA controller requests data. In single-address mode, SAR*n* provides the address regardless of the direction.

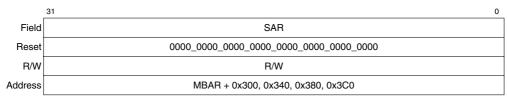


Figure 12-5. Source Address Registers (SARn)

NOTE:

SAR/DAR address ranges cannot be programmed to on-chip SRAM because it cannot be accessed by on-chip DMA.

12.4.2 Destination Address Registers (DAR0–DAR3)

For dual-address transfers only, DAR*n*, Figure 12-6, holds the address to which the DMA controller sends data.

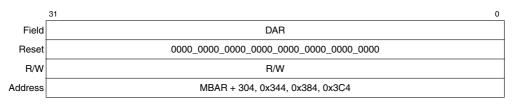


Figure 12-6. Destination Address Registers (DARn)

NOTE:

On-chip DMAs do not maintain coherency with MCF5407 caches and so must not transfer data to cacheable memory.

12.4.3 Byte Count Registers (BCR0–BCR3)

BCR*n*, Figure 12-7, holds the number of bytes yet to be transferred for a given block. BCR*n* decrements on the successful completion of the address transfer of either a write transfer in dual-address mode or any transfer in single-address mode. BCR*n* decrements by 1, 2, 4, or 16 for byte, word, longword, or line accesses, respectively.



Table 13-4. Time-Out Values (in Seconds)—TRR[REF] = 0xFFFF
(162-MHz Processor Clock) (Continued)

	CLK = 10 (÷ 1)		CLK = 01 (÷ 16)			CLK = 10 (÷ 1)			CLK = 01 (÷ 16)					
TMR[PS] (Dec)			CLKIN	(MHz)			TMR[PS] (Dec)	CLKIN (MI			(MHz)	z)		
	54	40.5	32.4	54	40.5	32.4		54	40.5	32.4	54	40.5	32.4	
6	0.136	0.181	0.227	0.008	0.011	0.014	134	2.621	3.495	4.369	0.164	0.218	0.273	
7	0.155	0.207	0.259	0.010	0.013	0.016	135	2.641	3.521	4.401	0.165	0.220	0.275	
8	0.175	0.233	0.291	0.011	0.015	0.018	136	2.660	3.547	4.434	0.166	0.222	0.277	
9	0.194	0.259	0.324	0.012	0.016	0.020	137	2.680	3.573	4.466	0.167	0.223	0.279	
10	0.214	0.285	0.356	0.013	0.018	0.022	138	2.699	3.599	4.499	0.169	0.225	0.281	
11	0.233	0.311	0.388	0.015	0.019	0.024	139	2.719	3.625	4.531	0.170	0.227	0.283	
12	0.252	0.337	0.421	0.016	0.021	0.026	140	2.738	3.651	4.563	0.171	0.228	0.285	
13	0.272	0.362	0.453	0.017	0.023	0.028	141	2.757	3.676	4.596	0.172	0.230	0.287	
14	0.291	0.388	0.485	0.018	0.024	0.030	142	2.777	3.702	4.628	0.174	0.231	0.289	
15	0.311	0.414	0.518	0.019	0.026	0.032	143	2.796	3.728	4.660	0.175	0.233	0.291	
16	0.330	0.440	0.550	0.021	0.028	0.034	144	2.816	3.754	4.693	0.176	0.235	0.293	
17	0.350	0.466	0.583	0.022	0.029	0.036	145	2.835	3.780	4.725	0.177	0.236	0.295	
18	0.369	0.492	0.615	0.023	0.031	0.038	146	2.854	3.806	4.757	0.178	0.238	0.297	
19	0.388	0.518	0.647	0.024	0.032	0.040	147	2.874	3.832	4.790	0.180	0.239	0.299	
20	0.408	0.544	0.680	0.025	0.034	0.042	148	2.893	3.858	4.822	0.181	0.241	0.301	
21	0.427	0.570	0.712	0.027	0.036	0.044	149	2.913	3.884	4.855	0.182	0.243	0.303	
22	0.447	0.595	0.744	0.028	0.037	0.047	150	2.932	3.910	4.887	0.183	0.244	0.305	
23	0.466	0.621	0.777	0.029	0.039	0.049	151	2.952	3.935	4.919	0.184	0.246	0.307	
24	0.485	0.647	0.809	0.030	0.040	0.051	152	2.971	3.961	4.952	0.186	0.248	0.309	
25	0.505	0.673	0.841	0.032	0.042	0.053	153	2.990	3.987	4.984	0.187	0.249	0.311	
26	0.524	0.699	0.874	0.033	0.044	0.055	154	3.010	4.013	5.016	0.188	0.251	0.314	
27	0.544	0.725	0.906	0.034	0.045	0.057	155	3.029	4.039	5.049	0.189	0.252	0.316	
28	0.563	0.751	0.939	0.035	0.047	0.059	156	3.049	4.065	5.081	0.191	0.254	0.318	
29	0.583	0.777	0.971	0.036	0.049	0.061	157	3.068	4.091	5.113	0.192	0.256	0.320	
30	0.602	0.803	1.003	0.038	0.050	0.063	158	3.087	4.117	5.146	0.193	0.257	0.322	
31	0.621	0.829	1.036	0.039	0.052	0.065	159	3.107	4.143	5.178	0.194	0.259	0.324	
32	0.641	0.854	1.068	0.040	0.053	0.067	160	3.126	4.168	5.211	0.195	0.261	0.326	
33	0.660	0.880	1.100	0.041	0.055	0.069	161	3.146	4.194	5.243	0.197	0.262	0.328	
34	0.680	0.906	1.133	0.042	0.057	0.071	162	3.165	4.220	5.275	0.198	0.264	0.330	
35	0.699	0.932	1.165	0.044	0.058	0.073	163	3.185	4.246	5.308	0.199	0.265	0.332	
36	0.718	0.958	1.197	0.045	0.060	0.075	164	3.204	4.272	5.340	0.200	0.267	0.334	
37	0.738	0.984	1.230	0.046	0.061	0.077	165	3.223	4.298	5.372	0.201	0.269	0.336	
38	0.757	1.010	1.262	0.047	0.063	0.079	166	3.243	4.324	5.405	0.203	0.270	0.338	
39	0.777	1.036	1.295	0.049	0.065	0.081	167	3.262	4.350	5.437	0.204	0.272	0.340	
40	0.796	1.062	1.327	0.050	0.066	0.083	168	3.282	4.376	5.469	0.205	0.273	0.342	
41	0.816	1.087	1.359	0.051	0.068	0.085	169	3.301	4.401	5.502	0.206	0.275	0.344	
42	0.835	1.113	1.392	0.052	0.070	0.087	170	3.320	4.427	5.534	0.208	0.277	0.346	





Baudrate =
$$\frac{54 \text{MHz}}{[32 \times \text{divider}]}$$

Let baud rate = 9600; the divider can be calculated as follows:

Divider = $\frac{54MHz}{[32 \times 9600]}$ = 176(decimal) = 0x00B0

Therefore UDUn = 0x00 and UDLn = 0xB0.

14.5.1.2.2 External Clock

An external source clock (TIN) can be used as is or divided by 16.

Baudrate = Externalclockfrequency 16or1

14.5.2 Transmitter and Receiver Operating Modes

Figure 14-29 is a functional block diagram of the transmitter and receiver showing the command and operating registers, which are described generally in the following sections and described in detail in Section 14.3, "Register Descriptions."

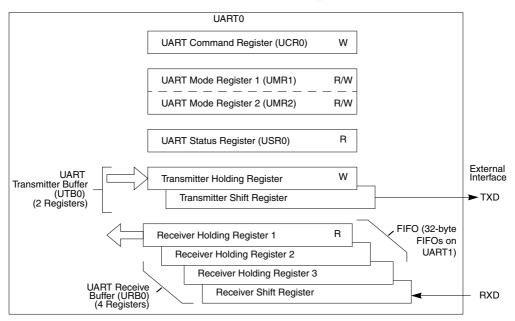


Figure 14-29. Transmitter and Receiver Functional Diagram



if a longword access occurs at a misaligned offset of 0x1, a byte is transferred first (SIZ[1:0] = 01), a word is next transferred at offset 0x2 (SIZ[1:0] = 10), then the final byte is transferred at offset 0x4 (SIZ[1:0] = 01).

For aligned transfers larger than the port size, SIZ[1:0] behaves as follows:

- If bursting is used, SIZ[1:0] stays at the size of transfer.
- If bursting is inhibited, SIZ[1:0] first shows the size of the transfer and then shows the port size.

SIZ[1:0]	Port Size
00	Longword
01	Byte
10	Word
11	Line

Table 17-4. Bus Cycle Size Encoding

For burst-inhibited transfers, SIZ[1:0] changes with each $\overline{\text{TS}}$ assertion to reflect the next transfer size. For transfers to port sizes smaller than the transfer size, SIZ[1:0] indicates the size of the entire transfer on the first access and the size of the current port transfer on subsequent transfers. For example, for a longword write to an 8-bit port, SIZ[1:0] = 00 for the first byte transfer and 01 for the next three.

17.2.5 Transfer Start (TS)

The MCF5407 asserts $\overline{\text{TS}}$ during the first clock cycle when address and attributes (TM, TT, $\overline{\text{TIP}}$, R/\overline{W} , and SIZ) are valid. $\overline{\text{TS}}$ is negated in the following clock cycle. When the MCF5407 is not the bus master, $\overline{\text{TS}}$ is an input.

17.2.6 Address Strobe (AS)

Address strobe (\overline{AS}) is asserted to indicate when the address is stable at the start of a bus cycle. The address and attributes are guaranteed to be valid during the entire period that \overline{AS} is asserted. This signal is asserted and negated on the falling edge of the clock. When the MCF5407 is not the bus master, \overline{AS} is an input.

17.2.7 Transfer Acknowledge (TA)

When the MCF5407 is bus master, the external system drives this input to terminate the bus transfer. The bus continues to be driven until this synchronous signal is asserted. For write cycles, the processor continues to drive data one clock after \overline{TA} is asserted. During read cycles, the peripheral must continue to drive data until \overline{TA} is recognized.

If all bus cycles support fast termination, \overline{TA} can be tied low. However, note that \overline{TA} cannot be tied low if potential external bus masters are present. The MCF5407 drives \overline{TA} for an

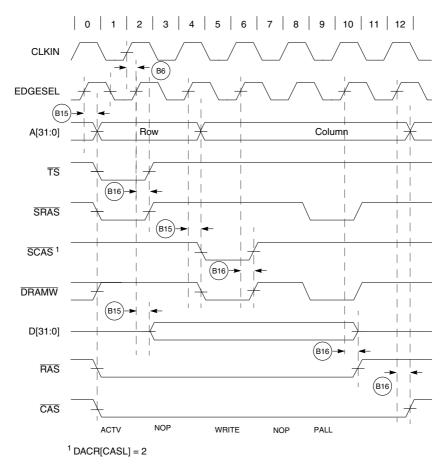


Figure 20-8. SDRAM Write Cycle with EDGESEL Tied to Buffered CLKIN

Figure 20-9 shows an SDRAM read cycle with EDGESEL tied high.